292272-5 <

AMP Mini CT

TE Internal #: 292272-5 PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 1.5 mm [. 059 in] Centerline, Fully Shrouded, Gold (Au), Through Hole -Solder, AMP Mini CT

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Wire-to-Board

Number of Positions: **5**

Number of Rows: 1

Features

Product Type Features

PCB Connector TypePCB Mount HeaderConnector SystemWire-to-BoardHeader TypeFully Shrouded

Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Connector Product Type	Connector Assembly	
Configuration Features		
PCB Mount Orientation	Vertical	
Number of Positions	5	
Number of Rows	1	
Electrical Characteristics		
Operating Voltage	50 VDC	
Body Features		
Primary Product Color	Natural	
Contact Features		
Contact Mating Area Plating Material Thickness	.38 μm[15 μin]	
Mating Square Post Dimension	.5 mm[.02 in]	
PCB Contact Termination Area Plating Material Thickness	.381 μm[15 μin]	

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Contact Shape & Form	Square	
Contact Layout	Staggered	
Contact Mating Area Length	2.4 mm[.095 in]	
Contact Base Material	Brass	
PCB Contact Termination Area Plating Material	Gold	
Contact Mating Area Plating Material	Gold (Au)	
Contact Type	Pin	
Contact Current Rating (Max)	2 A	
Termination Features		
Termination Post & Tail Length	3 mm[.118 in]	
Square Termination Post & Tail Dimension	.5 mm[.02 in]	
Termination Method to PCB	Through Hole - Solder	
Mechanical Attachment		
Mating Retention	With	
Mating Alignment Type	Polarization	
PCB Mount Retention Type	Kinked Legs	
PCB Mount Alignment Type	Locating Posts	

PCB Mount Retention	With	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Mating Alignment	With	
Housing Features		
Housing Material	Nylon (G.F)	
Centerline (Pitch)	1.5 mm[.059 in]	
Dimensions		
Connector Width	4.7 mm[.185 in]	
PCB Thickness (Recommended)	1.6 mm[.063 in]	
Connector Height	6.9 mm[.272 in]	
Connector Length	10 mm[.393 in]	
Usage Conditions		
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]	
Operation/Application		

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Assembly Process Feature	Pick and Place Cover
Circuit Application	Signal
Industry Standards	
Compatible With Agency/Standards Products	CSA, UL
Compatible With Approved Standards Products	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	850
Packaging Method	Box
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE

2024 (241)

Does not contain REACH SVHC

Not Low Halogen - contains Br or Cl > 900 ppm.

Wave solder capable to 265°C

Halogen Content

Solder Process Capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

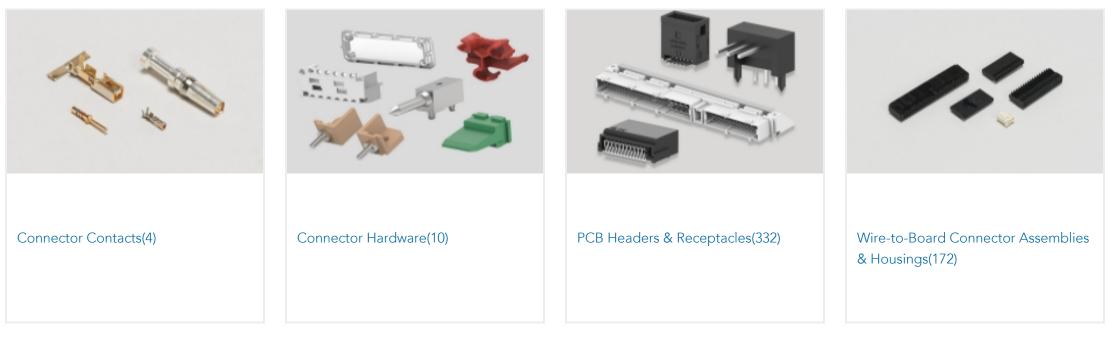
Compatible Parts

PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 1.5 mm [.059 in] Centerline, Fully Shrouded, Gold (Au), Through Hole - Solder, AMP Mini CT





Also in the Series | AMP Mini CT





Wire-to-Board Headers & Receptacles (332)

Customers Also Bought

TE Part #1717284-1	TE Part #1717284-3	TE Part #1717284-2	TE Part #1827984-2
RTD CONNECTOR PLUG CABLE ASSY			

Documents

Product Drawings S/R POST HDR ASSY V DIP AU-PL. 5P GRAY

English

CAD Files

3D PDF

3D

PCB Mount Header, Vertical, Wire-to-Board, 5 Position, 1.5 mm [.059 in] Centerline, Fully Shrouded, Gold (Au), Through Hole - Solder, AMP Mini CT



Customer View Model

ENG_CVM_CVM_292272-5_C1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_292272-5_C1.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_292272-5_C1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English

Agency Approvals UL

English